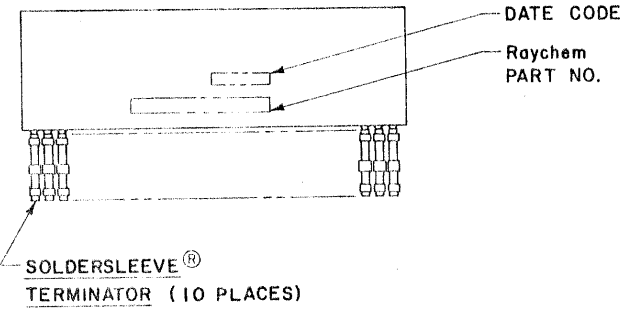
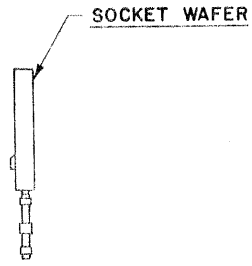


REVISIONS			
LTR	DESCRIPTION	DATE	APPROVED
2	REVISED PER ECN #T- 5869	4/1	[Signature]
A	RELEASED FOR PRODUCTION PER ECN T-012433	8/1/83	[Signature]



⚠ WEIGHT (MAX.):

LBS.	GRAMS
.0054	2.46

⚠ SOCKET NUMBER ONE IS MARKED IN CONTRASTING COLOR.

- | | | |
|-------------|---------------------|--|
| 3. FINISH: | 3-A SOCKET WAFER; | FINISH TO BE AS MOLDED. |
| | 3-B SOCKET CONTACT; | GOLD PLATE PER MIL-G-45204 CLASS I. |
| | (ENGAGING END) | |
| | 3-C CONTACT TAIL; | COATED WITH Sn63 SOLDER PER QQ-S-571 |
| 2 MATERIAL: | 2-A SOCKET WAFER; | HIGH GRADE POLYARYLENE THERMOPLASTIC. |
| | 2-B SOCKET CONTACT; | COPPER ALLOY PER QQ-B-750. |
| | 2-C SOLDERSLLEEVE® | REFER TO RAYCHEM DWG. CTA-0068 FOR DATA. |
| | TERMINATOR; | |

1. THIS WAFER ASSEMBLY USED IN MTC100 CONNECTORS.

**If this document is printed it becomes uncontrolled.
Check with the web for latest revision.**

SPECIFICATION CONTROL DRAWING © Raychem Corporation 1983

DRAWN	HAWKINGS	11-16-83	Raychem RAYCHEM CORPORATION 500 CONSTITUTION DRIVE MENLO PARK, CALIFORNIA 94025	
CHECKED	SB			
APPROVED	[Signature]	12-2-83	TITLE WAFER ASSEMBLY, SOCKET, "B" STYLE, 1", 10 CONTACTS, WITH OVAL ENTRY FOR 20-26 AWG. TEMP. RATING MTC100 SERIES	
APPROVED	[Signature]	12-2-83		
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES ±.005 METRIC DIMENSIONS ARE IN PARENTHESIS (M.M.)			SIZE	CODE IDENT NO
DO NOT SCALE THIS DRAWING			C	06090
			DWG NO	MTC100-JBI-S14
			WEIGHT	⚠
			SHEET 1 OF 1	

NOTES:

单击下面可查看定价，库存，交付和生命周期等信息

[>>TE Connectivity\(泰科\)](#)